

## PTC

| Product Class   | Overcurrent Protection SMD<br>B59xxxP1*<br>14.10.2019   |   |   |  |  |  |  |  |
|---|---|---|---|--|--|--|--|--|
| Date  |   |   |   |  |  |  |  |  |
| IMDS ID<br>if available   |   |   |   |  |  |  |  |  |
| Version   | 5.04  |   |   |  |  |  |  |  |
| Product Part<br>(IMDS: semi<br>component)   | Material Class<br>(IMDS: Material)  | <b>Material</b><br>(Classification)<br>VDA 231  | Substance   | TMPS**)<br>[wt%]   | CAS<br>if applicable   | typical mass of<br>material<br>[wt-%]  | Traces<br>see 1)   |  |
| Active Part   | Ceramic   | 3В  | Ba-titanates<br>Pb-titanates<br>Sr-titanates<br>Ca-titanates<br>others*)  | 67<br>12<br>10<br>10<br>1  | 12047-27-7<br>12060-00-3<br>12060-59-2<br>12049-50-2   | 27.9   |  |  |
| Termination   | Noble Metal<br>Heavy Metal<br>Heavy Metal   | 1D7<br>1C14<br>1C2  | Ag<br>Ni<br>Cr  | 100<br>100<br>100  | 7440-22-4<br>7440-02-0<br>7440-47-3  | 0.046<br>0.03<br>0.024   |  |  |
| Solder  | Heavy Metal   | 1C8   | Sn<br>Ag  | 96<br>4  | 7440-31-5<br>7440-22-4   | 2  |  |  |
| Leads<br>Encapsulation  | Heavy Metal<br>Heavy Metal<br>Thermoplastic   | 1C12<br>1C8<br>2A   | Cu<br>Sn<br>PPS GF40  | 100<br>100<br>100  | 7440-50-8<br>7440-31-5<br>26125-40-6   | 13.2<br>0.8<br>56  |  |  |
| Enoupsulation   | memoplastic   | 2/1   |   | 100  | Sum of total   | 100  |  |  |
| sizes [ mm]<br>3.3 x 6.3 x 8  | weight range [ g ]<br>0.4   | material numbers<br>B59101P1080*<br>B59101P1120*<br>B59115P1080*<br>B59115P1120*<br>B59215P1080*<br>B59215P1120*  |   | sizes [ mm]<br>3.3 x 8 x 10  | weight range [ g ]<br>0.6  | material numbers<br>B59315P1080*<br>B59315P1120*   |  |  |
| Not part of a Product (   | Class   |   |   |  |  |  |  |  |
| Contact   | Ronner Christoph  |   |   | Important remarks  | Important remarks:   |  |  |  |
| Division  | PPD Q QM 1) The declaration limit is 0.1% as defined by IEC 62474 (IEC PAS 61906). Trace<br>product parts, substances etc. that are below a percentage of 0.1% by weight, if not ot               |   |   |  |  |  | ,  |  |
| Address   | 8530 Deutschlandsberg<br>Tel:   | , AUSTRIA<br>mailto:  |   | regulated.   |  |  |  |  |
| *) others: .(not declarab<br>**) typical mass percent   | +43 3462 800 2139<br>le or prohibited substan   | functional.ppd-eqpm.db@t  | dk-electronics.tdk.com  | herein. We express<br>best present knowle<br>specifications, unle<br>AFFILIATES HERE<br>WHETHER EXPRE<br>AND VALUES COM  | al Data Sheet contains typica<br>sly point out that all values ar<br>edge and cannot be regarde<br>ess otherwise explicitly agree<br>EBY EXPRESSLY DISCLAIM<br>ESS, IMPLIED OR STATUTO<br>NTAINED HEREIN, INCLUDI<br>IN OR WARRANTY OF MER | nd statements contained he<br>d as binding statements or<br>d in writing. TDK ELECTRO<br>I ANY REPRESENTATION<br>NRY, WITH REGARD TO TH<br>NG BUT NOT LIMITED TO | rein are based on our<br>binding product<br>DNICS AG AND ITS<br>OR WARRANTY,<br>HE STATEMENTS<br>ANY |  |
| of the European Parlian   | nent and of the Council   | of June 8 <sup>th</sup> , 2011 on the   |   | re compatible with the requination reading the requination of the requ | irements according to Art. 4<br>in electrical and electronic e   |  | Directive 2011/65/EU   |  |
| □ Exemption 6 (b): Le   □ Exemption 6 (c): Co   □ Exemption 7 (a): Le   □ Exemption 7 (c): EI   □ Exemption 7 (c): Le   □ Exemption 7 (c): Le | ead as an alloying element in<br>opper alloy containing up to<br>ead in high melting temperat<br>ectrical and electronic comp<br>ead in dielectric ceramic in c<br>ead in dielectric ceramic in c | n aluminium containing up to<br>4 % lead by weight;<br>ure type solder (i.e. lead-bas<br>ponents containing lead in a g<br>apacitors for a rated voltage<br>apacitors for a rated voltage<br>viable electrical connection t | 0,4 % lead by weight;<br>ed alloys containing 85 % by w<br>plass or ceramic other than diek<br>of 125 V AC or 250 V DC or hig<br>of less than 125 V AC or 250 V | ectric ceramic in capacitors, e.g.<br>her;   | piezoelectronic devices, or in a g   | lass or ceramic matrix compoun   | d;   |  |